D2-4 Family Audio SOC

Intelligent Digital Amplifier PWM Controller and Audio Processor

FN6785
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Mar 19, 2019

The D2-4 Family (D2-41051 and D2-41151) (D2-45157-QR) devices are complete System on Chip (SoC) Audio Processor and Class-D Amplifier Controllers that offer a powerful yet very cost effective audio solution for high volume consumer products, including digital TV systems, PC multimedia speakers, and portable device docking stations. This 4th generation Digital Audio Processor (D2-4 family) device combines a feature-integrated DSP processing and configurable audio processing algorithms for complete audio system control.

The D2-4 family devices offer the optimum balance of functionality and reveal a proven-in-market and, especially in an fast system architecture with I²S audio output. All audio processing and amplifier control is handled by the IC efficiently, with its ease of integration to the existing system processor handles all system control functions.

Related Literature

For a full list of related documents, visit our website:

- D2-41051 and D2-41151 device pages

Features

- All digital class D amplifier controller with integrated Digital Signal Processing (DSP)
- Fully programmable audio signal path parameters
- Up to 5 channels of Digital Signal Processing (DSP)
- Includes equalizers, filters, mixers, and other common audio processing blocks
- Audio enhancement algorithms included
- I²S and I²S/TDM digital audio stereo inputs
- I²C host control port
- Asynchronous sample rate converters, sample rates from 32kHz up to 192kHz
- Supports 2.0, 2.1, or bridge amplifier outputs with discrete or integrated power stages

Applications

- PC/multimedia speakers
- Digital TV audio systems
- Portable device docking stations
- Powered speaker systems

FIGURE 1. TYPICAL APPLICATION

Table of Contents

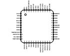
Ordering Information

[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	[illegible]
[illegible]	[illegible]	[illegible]	-40 to +85	-	[illegible]	[illegible]
[illegible]	[illegible]	[illegible]	-40 to +85	Yes	[illegible]	[illegible]
[illegible]	[illegible]	[illegible]	-40 to +85	-	[illegible]	[illegible]
[illegible]	[illegible]	[illegible]	-40 to +85	Yes	[illegible]	[illegible]

NOTES:

1. See [illegible] for details about reel specifications.
2. [illegible]
3. [illegible]
4. For Moisture Sensitivity Level (MSL), see the [illegible]

Pin Configuration



D2-4 Family Pin Descriptions

PIN	PIN NAME (Default)	TYPE	VOLTAGE (V)	DRIVE STRENGTH (mA)	DESCRIPTION
1	SCLK	I	3.3		PCworld audio bit clock (SCLK) Input. Input has hysteresis.
2	SDIN	I	3.3		PCworld audio data (SDIN) Input. Input has hysteresis.
3	LRCK	I	3.3		PCworld audio left/right (LRCK) Input. Input has hysteresis.
4	MCLK	I	3.3		PCworld audio master clock output for external (MCLKO) and input for internal clocks. Input has no int. Output is as Bidirectional.
5, 42	CVDD	P	3.3		Core power, 1.2 Vdc. Used to feed on-chip internal DSP logic, and int ernal core.
6, 43	CGND	P	0.0		Core ground.
7, 45	RVDD	P	3.3		Digital pad ring ground. Internally connected to PVMIXGND.
8, 46	RGND	P	0.0		Digital pad ring power, 3.3V. The 3.3V supply is a user feed for off the digital I/O pad drivers and resistors, except for the analog pads. Both vdc required to be connected. Internally connected to PVMIXVDD.
9	TEMPREF/ SDA	I/O	3.3	4/8	Temperature monitor reference for the monitor and DPI clock. Bi-directional bidirectional mask, chip pin operates as a SPI clock. Open-connect I2C A family firmware mode, this pin becomes an input for monitoring temperature.
10	VOUT1/ SCL	I/O	3.3	4/8	Volume control pulse input and SPI master/output. Master output clock signal. Bi-directional bidirectional mask, chip pin operates as a SPI clock. Open-connect I2C A family firmware mode, this pin becomes an input for monitoring up/ volume pulse input from external rotary encoder.
11	VOUT2/ MISO	I/O	3.3	4/8	Volume control pulse input and SPI master/output. Master input data signal. Bi-directional bidirectional mask, chip pin operates as a SPI clock. Open-connect I2C A family firmware mode, this pin becomes an input for monitoring temperature.
12	SPDIFIN	I	3.3		S/PDIF digital audio data input.
13	SPDIFTX	O	3.3	8	S/PDIF digital audio data output. This pin is the S/PDIF audio output and drives Bi-mask, 3.3V stereo output up to 192kHz. Pin is 5V tolerant.
14	TDO	O	3.3		Hardware boot mode control. For factory use only. Must be tied low.
15	VRQA	I	3.3		Interrupt request port 0. One of nine GPIOs (yes, low) to logic 3.3V) high or ground. High, low logic volume or address bus mode selection is open-drain version of the host. with I2C option.
16	VRQB	I	3.3		Interrupt request port B. One of nine GPIOs (yes, low) to logic 3.3V) high or ground. High, low logic volume or address bus mode selection is open-drain version of the host. with I2C option.
17	ADR0/A/ CPCS	I/O	3.3	4/8	Device configuration address input and SPI/I2C output. Open-connect mask, this pin operates as an input, using application bidirectional pull-up or pull-down connection to the pin (usually) one of four amplifier configurations. Open-connect I2C A family firmware mode, this pin becomes an output and provides a one-shot/ analog signal to the serial power supply controller.
18	PSEN/C/ CPCL	I/O	3.3	4	Device configuration selection input and SPI/I2C output. Open-connect bidirectional mask, chip pin operates, as an input, using application bidirectional pull-up or pull-down connection to the pin (usually) one of four amplifier configurations. Open-connect I2C A family firmware mode, this pin becomes an output and provides a one-shot/analog signal to the serial power supply controller.

D2-4 Family Pin Descriptions (Continued)

Pin	Pin Name Multiple Functions	Type	Voltage (V) Tolerance	Drive (mA)	Description
23	PWDTRST0	I/O	3.3	4	PWM protection input. Input to activate the protection mechanism. Protection monitoring functionality of these pins is controlled by an internal D2-4 family firmware, and dependent on which of the four amplifier configurations is enabled.
24	PWDTRST2	I/O	3.3	4	
25, 26	PWM0/1	P	3.3	8 ma	PWM output pins ground, internally connected to PGND.
27	PWM7	I/O	3.3	8 ma / 16	PWM outputs. Output is 8mA or 16mA, depending on the output mode configuration setting. Pins float on reset.
28	PWM6	I/O	3.3	8 ma / 16	
29	PWM5	I/O	3.3	8 ma / 16	
30	PWM4	I/O	3.3	8 ma / 16	
31, 32	PWM2/3	P	3.3	8 ma	PWM output pins ground. Note, D2-4 supply is used for the PWM ground drivers, internally connected to PGND.
33	PWM3	I/O	3.3	8 ma / 16	PWM outputs. Output is 8mA or 16mA, depending on the output mode configuration setting. Pins float on reset.
34	PWM2	I/O	3.3	8 ma / 16	
35	PWM1	I/O	3.3	8 ma / 16	
36	PWM0	I/O	3.3	8 ma / 16	
37	PLLVDD	P	1.8		PLL analog ground
38	XTALI	P	1.8		Crystal oscillator analog input pin
39	XTALO	P	1.8		Crystal oscillator analog output pin. To boost/quiet drive the crystal oval XTALO state, set have a drive strength specification.
40	PLLGND	P	1.8		PLL analog ground
41	VDLL/ uVS	P	1.8	4	Volume control pulse input and SPI slave select. At deassertion of device reset, this pin operates as a SPI slave select input. Upon internal D2-4 family firmware execution, this pin becomes an input for monitoring up/down pulse pulses from volume control device connected to this pin.
42	nRESET	I	3.3	Int. 100	Active low output. This pin drives low for the 3.3V brownout detector or 1.8V brownout detector trip point. Also, this pin drives low to indicate a system reset due to nRESET pin pulled low/reset event detection.
43	nRESET	I	3.3		Active low reset input. Synchronous, low level activates system level reset. Asynchronous, low level activates reset in all operation. Suite includes low reset detection on this IRQ input pins on the rising edge.
44	TEMPSNK/ GPIO0	I/O	3.3	16	Temperature monitor connection (TS) pin.
45	SCL	I/O	3.3	8 - 200	Two-Wire serial data or slave control pin with Schmitt-trigger. Bidirectional signal used by both the master and slave controllers for clock signaling. Pin is open-drain.
46	SDA	I/O	3.3	8 - 200	Two-Wire serial clock pad, open-drain driver with Schmitt-trigger. Bidirectional signal used by both the master and slave controllers for data signaling. Pin is open-drain.

NOTES:

1. All pins are active high, unless otherwise specified. Pins that are active low have an "n" prefix, such as nRESET.
2. All inputs are 3V5 and are open-drain drivers.
3. All power and ground pins of the same name are must be tied together to all other pins of that same name (for example, tie the PVDD pins together, PGND pins together, VDDD pins together, GDAD pins together, PWMVDD pins together, and PWMGND pins together).

Absolute Maximum Ratings [illegible]

[illegible]

Thermal Information

[illegible]

[illegible]

Recommended Operating Conditions

[illegible]

Parameter	Symbol	Min	Typ	Max	Unit
[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	V
[illegible]		-	[illegible]	-	[illegible]
[illegible]		-	[illegible]	-	[illegible]
[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	V
[illegible]		-	[illegible]	-	[illegible]
[illegible]		-	[illegible]	-	[illegible]
[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	V
[illegible]		-	[illegible]	-	[illegible]
[illegible]		-	[illegible]	-	[illegible]

[illegible]

Electrical Specifications

[illegible]

Parameter	Symbol	Min	Typ	Max	Unit
[illegible]	[illegible]	[illegible]	-	-	V
[illegible]	[illegible]	-	-	[illegible]	V
[illegible]	[illegible]	[illegible]	-	-	V
[illegible]	[illegible]	-	-	[illegible]	V
[illegible]	[illegible]	[illegible]	-	[illegible]	V
[illegible]	[illegible]	-	-	[illegible]	V
[illegible]	-	-	-	[illegible]	[illegible]
[illegible]	[illegible]	-	[illegible]	-	pF
[illegible]	[illegible]	-	[illegible]	-	pF
[illegible]	[illegible]	-	[illegible]	-	[illegible]

Electrical Specifications T_A = -20 °C, CVDD = PLLVDD = 1.8V ±5%, RVDD = PAVRDD = 3.3V ±5%, all grounds at 0V, 40 oscillator fundamental crystal (Fund. XTL), or 24.576MHz, 1.8V or 3.3V CMOS clock source, unless otherwise noted (Continued)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
CRYSTAL OSCILLATOR					
Crystal Frequency (Fundamental Mode Crystal)	fxo	20	24.576	25	MHz
Duty Cycle	Dtc	40	-	60	%
Start-Up Time (Start-Up Time is Oscillator-enabled at both Valid Supply) to Stable Oscillation)	tstart	-	5	20	ms
PLL					
VCO Frequency	Fvco	240	294.912	300	MHz
PLL Lock Time from de-asserted Powerdown	tlock	-	5	-	ms
I2C POWER-ON RESET					
Reset Enabled Voltage Level	Vpor	0.95	1.10	1.30	V
POR Minimum Output Pulse Width	Tpw	-	5	-	ms
I2C COMPONENT SPECIFICATIONS					
Clock Frequency		1.4	1.5	1.7	V
Pulse Width Rejection	Tfse45	-	100	-	ns
Minimum Output Pulse Width	Tp_h	20	-	-	ns
SPI (SPIM) COMPONENT SPECIFICATIONS					
Clock Cycle		2.4	2.7	2.9	V
Pulse Width Rejection	Tfse50	-	100	-	ns
Minimum Output Pulse Width	Tx3	-	20	-	ns

NOTES:
12. All input pins except XTAL0.
13. All digital outputs. Drive strength for each digital pin is in the "D2-4 Family Pin Descriptions" on page 2.
14. Input leakage applies to all pins except XTAL0.

Serial Audio Interface Port Timing T_A = -20 °C, CVDD = PLLVDD = 1.8V ±5%, RVDD = PAVRDD = 3.3V ±10%, CLOAD = 20 MAXIMUM, MEDIUM DRIVE STRENGTH, 40 MHz CRYSTAL OR 24.576 MHz CLOCK SOURCE

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
SCLK Period (SCLK)	tsclkp	40	-	10.0	ns
SCLK Pulse Width (HIGH and LOW) (SCLK)	tsclkh	40	-	-	ns
LRSR Set-Up to SCLK Rising Edge (LRSR)	tslrsh	20	-	-	ns
LRSR Hold from SCLK Rising (LRSR)	tshlr	20	-	-	ns
SDTR Set-Up to SCLK Rising Edge (SDTR)	tsdt	20	-	-	ns
SDTR Hold from SCLK Rising (SDTR)	tshdt	20	-	-	ns

[illegible]

Two-Wire (I²C) Interface Port Timing

[illegible]

[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	[illegible]
SCL Frequency	[illegible]	—	—	400	kHz
Bus Free Time Between Transmissions	[illegible]	[illegible]	—	—	μs
SCL Clock Low	[illegible]	[illegible]	—	—	μs
SCL Clock High	[illegible]	[illegible]	—	—	μs
Setup Time for a (Repeated) Start	[illegible]	[illegible]	—	—	μs
Start Condition Hold Time	[illegible]	[illegible]	—	—	μs
[illegible]	[illegible]	—	[illegible]	—	[illegible]
[illegible]	[illegible]	[illegible]	—	—	ns
[illegible]	[illegible]	—	—	0.9	μs
[illegible]	[illegible]	—	—	6	μs
[illegible]	[illegible]	—	—	[illegible]	μs
[illegible]	[illegible]	[illegible]	—	—	μs

NOTES:

8A. [illegible]

8B. [illegible]

[illegible]

SPI™ Master Mode Interface Port Timing

[illegible]

[illegible]	[illegible]	[illegible]	[illegible]	[illegible]
[illegible]	[illegible]	-	[illegible]	[illegible]
[illegible]	[illegible]	[illegible]	-	[illegible]
[illegible]	[illegible]	[illegible]		
[illegible]	[illegible]	[illegible]		

SPI™ Slave Mode Interface Port Timing

[illegible]

[illegible]	[illegible]	[illegible]	[illegible]	[illegible]
[illegible]	[illegible]	[illegible]		
[illegible]	[illegible]	[illegible]	-	[illegible]
[illegible]	[illegible]	[illegible]		
[illegible]	[illegible]	[illegible]		

Overview

[illegible]

Output Configurations

[illegible]

Programmable Audio Processing

[illegible]

Typical Performance

[illegible]

Audio Enhancement Processing

The D2-4 family devices include 32-bit Audio DSP Sound Processing Technology (SPT) and 32-bit Audio DSP Sound Effects and DRAM (SEDR) SPT functions for D2-4 audio enhancement algorithms. These functions are integrated within the firmware of each device and are part of the standard audio signal flow.

Functional Description

Figure Block Diagram (1) shows a block diagram of the D2-4 family devices and is meant as a reference for many of the items in the following descriptions.

Serial Audio Digital Input

The D2-4 family devices have three Serial Audio Interface (SAI) port accessories that can determine all digital audio input. The SAI supports I²S, LJ, RJ, TDM, and PDM data formats and can operate in up to 256 bit TDM audio modes. The SAI input can operate in slave mode only. The digital audio input from the SAI input port routes directly through the Sample Rate Converter (SRC). Either TDM, I²S digital input or the S/PDIF digital input can be selected as the main audio input.

S/PDIF Digital Audio I/O

The D2-4 family contains one IEC60958 compliant S/PDIF Digital receiver input and one IEC60958 compatible S/PDIF Digital transmitter.

The S/PDIF receiver input includes an input transition detector, PLL, and error detection. The S/PDIF receiver has 8 channel status bits. The receiver meets the jitter tolerance specified in IEC60958-4.

The S/PDIF transmitter complies with the consumer applications defined in IEC60958-3. The transmitter supports 24-bit audio data, but does not support user bit and channel status.

Compressed digital formats are not decoded within the D2-4 family. However, a bitstream passthrough mode is supported from the SPDIFIN1 input to the SPDIFTX output, which allows for the passthrough of Dolby Digital, DTS, and other types of compressed audio input bitstream to make available at the product's S/PDIF output.

Sample Rate Converter

The D2-4 family devices include a 2-channel asynchronous Sample Rate Converter (SRC). The SRC converts audio data input sampled at one input sample rate to a fixed 48kHz output sample rate that aligns asynchronous input audio streams to a single rate for system processing. With an input sample rate between 8kHz and 192kHz, the SRC can convert any of the data from either the SAI or I²S/ PDIF input sources. In addition to converting the input sample rate to the output sample rate, input clock jitter and sampling jitter are attenuated by the SRC.

DSP

A 24-bit fixed point Digital Signal Processor (DSP) controls the audio signal flow and general system control functions within the D2-4 family devices.

Audio path signal routing, programmable parameter processing blocks, and control logic are defined within the device's internal firmware. Signal flow through the devices are buffered and processed through software specific function blocks, such as the SDR.

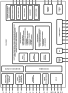
Audio Processing and Signal Flow

The audio processing within the D2-4 family devices is defined by the internal ROM firmware and executed by the DSP. This firmware defines the audio flow architecture and the processing blocks that are available. Figure Audio Processing and Signal Flow (2) shows the D2-4 family devices' internal audio processing functions within this architecture include:

- Mixer functions
- Routers
- Compressors and limiters
- Tone controls
- Multi-band equalizers (fully parametric and shelving)
- High-pass and low-pass crossover filters
- Volume and level controls
- Loudness compensation
- Input signal selection

Signal flow and input system definition is defined by the internal ROM firmware and executed as sub-block in programmable, which allows for adjustment of all of the parameters.

Signal flow and details of each of these audio processing blocks are shown in Figure 4.



Audio Enhancement Feature Processing

[illegible]

PWM Audio Outputs

[illegible]

I/O Control Pins

[illegible]

Timers

[illegible]

I²C 2-Wire Control Interface

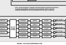
[illegible]

Serial Peripheral Interface (SPI)

[illegible]

Control Register Summary

[illegible]



Temperature Sensing

[illegible]

[illegible]

Overcurrent Sensing

[illegible]

[illegible]

[illegible]

[illegible]

[illegible]

Power Supply Synchronization

[illegible]

[illegible]

Error Reporting

[illegible]

[illegible]

[illegible]

[illegible]

Power Sequencing

[illegible]

Clock and PLL

[illegible]

[illegible]

[illegible]

Reset and Device Initialization

[illegible]

[illegible]

[illegible]

[illegible]

Boot Modes

The D2-4 family device contains internal firmware to operate the chip. The boot mode determines how the internal firmware is loaded by the programmable settings can be written to the device after it is operational and running.Parameter data can also be read at boot time, which allows saved parameter settings to be used in processing. The device is designed to boot in one of four possible boot configurations and data to be provided from these boot sources.

- I²C slave (to external microcontroller)
- I²C EEPROM
- Internal device ROM only
- SPI slave

The specific boot mode is selected based on the state of the IRQ/Boot/HID input pins at the time of reset de-assertion. Boot modes are shown in Table 2.

Table 2. Boot Mode Configuration

Boot Mode	IRQ/Boot Pin	HID Pin	Boot Source	Description
0	0	0	I²C Slave	Operates as I²C slave, boot at address 0x60. An external Master must provide boot code from I²C port.
1	0	1	I²C Master	Operates as I²C master, boot code from ROM on I²C port.
2	1	0	Internal ROM	Boot from internal ROM.
3	1	1	SPI Slave	SPI slave. External SPI master provides boot code.

The device initializes on all three of its boot mode. However, it gets its configuration and parameter data from the host device. Therefore, the host device must be operational before the D2-4 EEPROM. If a system uses both an external controller and an EEPROM, the EEPROM loads first. During this time, the controller must remain off the I²C bus.

Output Mode Configurations

The D2-4 family devices support four amplifier output configuration modes of powered output and line output combinations. These four modes are shown in Table 3.

Table 3. D2-4 Output Configuration Modes

MODE	PWM OUTPUTS	FUNCTION
0	2.0L/R Stereo	Powered Left and Right Speakers with 2-Channel Line Outputs
1	2.0L/R + 1L/R Sub	Powered Left and Right Speakers with 2-Channel Line Outputs Bridge-Tied Stereo Sub + Right Line-Level Output
		Dual-Ended Subwoofer Line-Level Output
2	2.0L/R + 1L/R Sub	Powered Left and Right Speakers with 2-Channel Line Output Bridge-Tied Stereo Sub + 2-Channel Line Output
		Full-Band Subwoofer Line-Level Output
		Bridge-Tied Stereo Sub + Right Line-Level Output
3	2.0L/R Bridge	Powered Left and Right Speakers with 2-Channel Line Outputs
		Bridge-Tied Stereo Sub Applied to Signal Pins

These configuration modes use different combinations of the four PWM output channels, and the audio signal routing to PWM pins is their appropriate PWM channel path. This channel connection and mapping of the signals is shown in Table 4 through 7. Of the total eight PWM pins, not all pins are used with every configuration mode. Pins not used in a specific configuration mode can be used as automatically generated line-level output pins or left in three-state pins are connected to their designated output stages.

In Mode 2 and 3, the PWM pins 7 through 10 are configured to be applied to the audio signal flow path, enabling the appropriate signal to be driven directly to the properly filtered PWM output channels.

The control pin inputs are mapped to the PWM channels that are used for the powered outputs. This protect pin-mapping assignment is shown in Table 8 through 11 for each configuration.

Configuration Mode Assignment

The configuration mode is assigned when the D2-4 family device exits its reset state. At that time, the logic status of the IRQ/Boot/HID pin is latched to determine the specific internal device registers. During this initialization time, these pins operate as logic inputs. After completion of the initialization and the internal firmware begins executing, these pins are reassigned as outputs for their shared functions. The internal latched logic value is not changed during this reassignment process. When the device is powered down or reset again, the in-mode requires a specific amplifier design's hardware connection, and the configuration pin logic levels are defined through pull-up or pull-down resistors installed on that design's board. These resistors are part of the design and are not intended to be changed for each hardware design.

[illegible]

[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	[illegible]
0	BTL/SE Adjustment	0	0	0	Left	0,4	0	Adjustment Half Bridge	Powered Left
				1	Right	2,7	1	Adjustment Half Bridge	Powered Right
				2	-	-	-	-	-
				3	-	-	-	-	-
				4	-	-	-	-	-
1	BTL/SE + Aux	0	1	0	Left	0,5	0	Adjustment Half Bridge	Powered Left
				1	Right	2,3	1	Adjustment Half Bridge	Powered Right
				2	-	-	-	-	-
				3	-	-	-	-	-
				4	-	-	-	-	-
2	BTL/SE + Aux	0	1	0	Left	0,5	0	Adjustment Half Bridge	Powered Left
				1	Right	2,3	1	Adjustment Half Bridge	Powered Right
				2	Center	6	-	Interleaved	Aux Headphone Left
				3	Mono	7	-	Interleaved	Aux Headphone Right
				4	Sub	8,9	-	Interleaved	Interleaved Sub
3	SE + Aux + Mono	1	0	0	Left	0,5	0	Half Bridge	Powered Left
				1	Right	2,3	1	Half Bridge	Powered Right
				2	Center	6	-	Interleaved	Aux Headphone Left
				3	Mono	7	-	Interleaved	Aux Headphone Right
				4	Sub	8,9	0	Adjustment Half Bridge	Powered Sub
4	2.1 Bi-Amp	1	1	0	L Hi Freq	0,5	0,1	Half Bridge	Powered Left HF
				1	L Lo Freq	2,3	1,2	Half Bridge	Powered Left LF
				2	R Hi Freq	4,5	2	Half Bridge	Powered Right HF
				3	R Lo Freq	6,7	3	Half Bridge	Powered Right LF
				4	-	-	-	-	-

Revision History

The revision history provided for the informational purposes only and is believed to be accurate, but not warranted. Please go to the web to make sure that you have the latest revision.

Date	Revision	Details
Mar 28, 2019	FN0763.2	Changed the base parts on page 2 in header to 32-bit Family Audio SOC. Updated Related Literature table. Replaced all words around "32-bit DSP" to "32 Audio DSP", "DdS-I" to "32-bit family", "Digital Audio Suite" to "Audio Software Framework", "SoundBuilder" to "Sound Enhancement Algorithm", "DSP Course II" to "32 Audio Customization SDK". Updated Audio Enhancement Feature Processing bullet points on page page 23. Updated Ordering Information table. Updated Figures 2, 3, 4, 5, and 6. Removed About Intersil section. Updated Trademarks section. Updated disclaimers.
May 5, 2016	FN0763.1	Updated entire datasheet applying Intersil's new standards. Updated Part Ordering Information table on page 5. Updated Note 8 on page 6. Updated Disclaimer to Renesas (DRS) Technology License Required Notice. Added Revision History section. Replaced Products on page to About Intersil verbiage. Updated About Intersil verbiage to these changes are as follows: About Intersil — Intersil Corporation is a pioneer in innovative ics. Our "dimension applies to..." to those from where dimensions were in metric format. Removed Notes #1, 6, and 8 in a line with.

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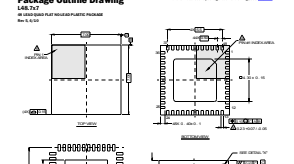
Package Outline Drawing

For the most recent package outline drawing, see L48.7x7.

L48.7x7

48 LEAD QUAD FLAT NO-LEAD PLASTIC PACKAGE
Rev 0, 6/10



NOTES:

1. Dimensions are in millimeters.
   Dimensions in ( ) for Reference Only.
2. Dimensioning and tolerancing conform to ASME Y14.5m-1994.
3. Unless otherwise specified, tolerance : Decimal ± 0.05
4. Dimension applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
5. Tiebar shown (if present) is a non-functional feature.
6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.

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